

# TN1515-600B

## Standard 15 A SCRs

#### Datasheet - production data



### **Features**

- On-state RMS current, I<sub>T(RMS)</sub>: 15 A
- Repetitive peak off-state voltage, V<sub>DRM</sub>/V<sub>RRM</sub>: 600 V
- Triggering gate current, IGT: 15 mA
- DPAK surface mount package

### Application

- Universal motor DC phase control
- Power supply crowbar circuit
- Power Supply inrush limiter
- Motor soft start controller
- AC-DC voltage regulator

### **Benefits**

- High AC surge current density
- Compact DPAK foot print

### September 2015

DocID12231 Rev 3

1/8

## Description

The TN1515-600B is a 15 A thyristor SCR housed in DPAK package. It fits any high voltage application that requires a high power density and compact housing design.

Symbol	Value	Unit
I <sub>T(RMS)</sub>	15	A
V <sub>DRM</sub> /V <sub>RRM</sub>	600	V
I <sub>GT (Q1)</sub>	15	mA

## 1 Characteristics

Symbol	Parameter			Value	Unit
I <sub>T(RMS)</sub>	On-state RMS current (180° conduction angle)		T <sub>c</sub> = 109 °C	15	A
I <sub>T(AV)</sub>	Average on-state current (180° cond	uction angle)	T <sub>c</sub> = 109 °C	9.5	A
1.	Non repetitive surge peak	t <sub>p</sub> = 8.3 ms	— T <sub>j</sub> = 25 °C	165	A
'TSM	TSM on-state current	t <sub>p</sub> = 10 ms		150	
l <sup>2</sup> t	I <sup>2</sup> t value for fusing	t <sub>p</sub> = 10 ms	T <sub>j</sub> = 25 °C	113	A <sup>2</sup> S
dl/dt	$ \begin{array}{ c c c } \hline Critical rate of rise of on-state \\ current I_G = 2 \ x \ I_{GT}, \ t_r \leq 100 \ ns \end{array} \hspace{0.5cm} F = 120 \ Hz \\ \end{array} $		T <sub>j</sub> = 125 °C	50	A/µs
I <sub>GM</sub>	Peak gate current $t_p = 20 \ \mu s$		T <sub>j</sub> = 125 °C	4	А
P <sub>G(AV)</sub>	Average gate power dissipation $T_j = 125 \text{ °C}$			1	W
T <sub>stg</sub> T <sub>j</sub>	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125	°C
V <sub>RGM</sub>	Maximum peak reverse gate voltage			5	V

#### Table 2. Absolute ratings (limiting values)

## Table 3. Standard electrical characteristics ( $T_j = 25 \text{ °C}$ , unless otherwise specified)

Symbol	Test conditions		Test conditions Values		Unit
1	V = 12 V P = 22 O	T - 25 °C	MIN.	2	m (
I <sub>GT</sub>	$V_{out} = 12 \text{ V}, \text{ R}_{L} = 33 \Omega$	T <sub>j</sub> = 25 °C	MAX.	15	mA
V <sub>GT</sub>	$V_{out}$ = 12 V, R <sub>L</sub> = 33 $\Omega$		MAX.	1.3	V
V <sub>GD</sub>	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega$	T <sub>j</sub> = 125 °C	MIN.	0.2	V
Ι <sub>Η</sub>	I <sub>T</sub> = 500 mA	MAX.	40	mA	
۱ <sub>L</sub>	$I_{\rm G} = 1.2 I_{\rm GT}$		MAX.	60	mA
dV/dt	$V_D = 67\% V_{DRM,}$ gate open	T <sub>j</sub> =125 °C	MIN.	200	V/µs
V <sub>TM</sub>	$I_{TM} = 30 \text{ A}$ $t_p = 380  \mu \text{s}$	T <sub>j</sub> = 25 °C	MAX.	1.6	V
V <sub>TO</sub>	Threshold voltage	T <sub>j</sub> = 125 °C	MAX.	0.85	V
R <sub>D</sub>	Dynamic resistance $T_j = 125 \text{ °C}$		MAX.	25	mΩ
I <sub>DRM</sub>	<u> </u>	T <sub>j</sub> = 25 °C	MAX.	5	μA
I <sub>RRM</sub>	$V_D/V_R = V_{DRM} = V_{RRM}$	T <sub>j</sub> = 125 °C		2	mA



Table 4. Thermal resistance					
Symbol	Symbol Parameter			Unit	
R <sub>th(j-c)</sub>	Junction to case (DC)		1.2	°C/W	
R <sub>th(j-a)</sub>	Junction to ambient	$S^{(1)} = 0.5 \text{ cm}^2$	70	°C/W	

1. S = Copper surface under tab







Figure 9. Junction to ambient thermal resistance versus copper surface under tab, PCB FR4, copper thickness 35µm





## 2 Package information

- Epoxy meets UL94, V0
- Lead-free packages
- Halogen-free molding resin
- Recommended torque: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

### 2.1 DPAK package information



Figure 10. DPAK package outline

Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.



DocID12231 Rev 3

	Dimensions					
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	2.18		2.40	0.086		0.0944
A1	0.9		1.10	0.035		0.0433
A2	0.03		0.23	0.0011		0.0090
b	0.64		0.90	0.0251		0.0354
b4	4.95		5.46	0.1948		0.2149
С	0.46		0.61	0.0181		0.0240
c2	0.46		0.60	0.0181		0.0236
D	5.97		6.22	0.2350		0.2448
D1	4.95			0.1948		
E	6.35		6.73	0.2500		0.2649
E1	4.32			0.1700		
е		2.286			0.09	
e1		4.572			0.18	
н	9.35		10.40	0.3681		0.4094
L	1.0		1.78	0.039		0.0700
L2			1.27			0.0500
L4	0.6		1.02	0.023		0.0401
V2	-8°		+8°	-8°		+8°

Table 5. DPAK package mechanical data

Figure 11. Footprint (dimensions in mm)



Note: T

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

DocID12231 Rev 3



## **3** Ordering information

- ignit i = i tit	iering mormation schema
	TN 15 15 - 600 B (-TR)
SCR series	
RMS Current	
15 = 15 A	
Sensitivity	
15 = 15 mA	
Voltage	
600 = 600 V	
Package	
B = DPAK	
Packing mode	
Blank = Tube	
-TR = Tape and reel	

Figure 12. Ordering information schema

#### Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
TN1515-600B	TN15 15600	DPAK	0.3 g	75	Tube
TN1515-600B-TR	TN15 15600	DPAK	0.3 g	2500	Tape and reel

## 4 Revision history

#### Table 7. Document revision history

Date	Revision	Changes
13-Mar-2006	1	Last update.
11-Jul-2007	2	TO-220AB delivery mode changed from bulk to tube.
21-Sep-2015	3	Updated <i>Features</i> , <i>Application</i> , <i>Description</i> and <i>Benefits</i> on cover page.Updated <i>Figure</i> 7, package information and reformatted to current standard.



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DocID12231 Rev 3

